

# 2SB1503

## Silicon PNP epitaxial planar type Darlington

For power amplification

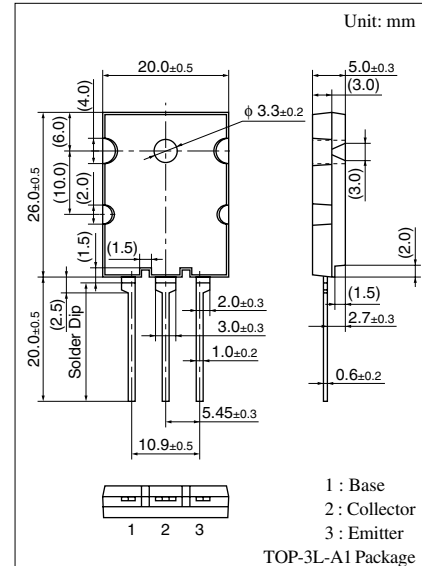
Complementary to 2SD2276

### ■ Features

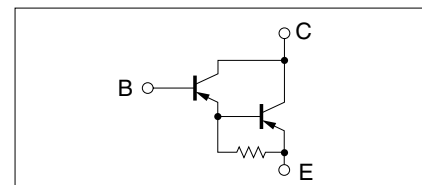
- Optimum for 110 W Hi-Fi output
- High forward current transfer ratio  $h_{FE}$ : 5 000 to 30 000
- Low collector to emitter saturation voltage  $V_{CE(sat)}$ :  $< -2.5$  V

### ■ Absolute Maximum Ratings $T_C = 25^\circ\text{C}$

Parameter		Symbol	Rating	Unit
Collector to base voltage		$V_{CBO}$	−160	V
Collector to emitter voltage		$V_{CEO}$	−140	V
Emitter to base voltage		$V_{EBO}$	−5	V
Peak collector current		$I_{CP}$	−12	A
Collector current		$I_C$	−7	A
Collector power dissipation	$T_C = 25^{\circ}\text{C}$	$P_C$	120	W
	$T_a = 25^{\circ}\text{C}$		3.5	
Junction temperature		$T_j$	150	$^{\circ}\text{C}$
Storage temperature		$T_{\text{stg}}$	−55 to +150	$^{\circ}\text{C}$



### Internal Connection

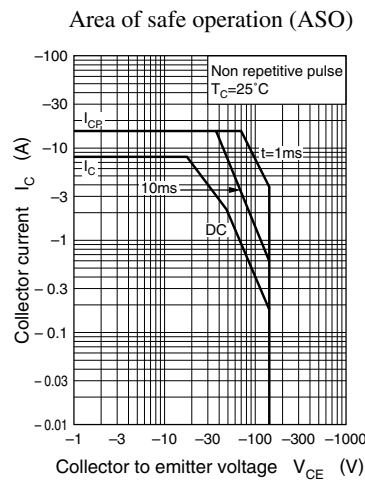
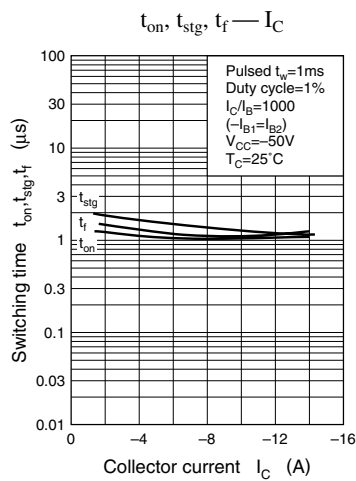
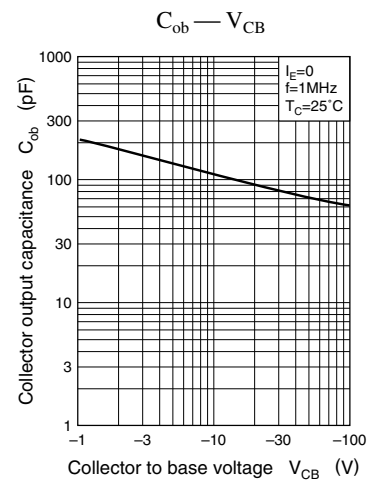
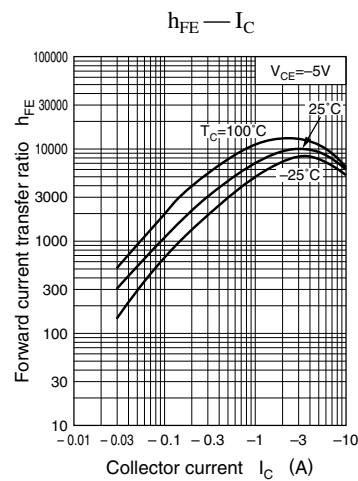
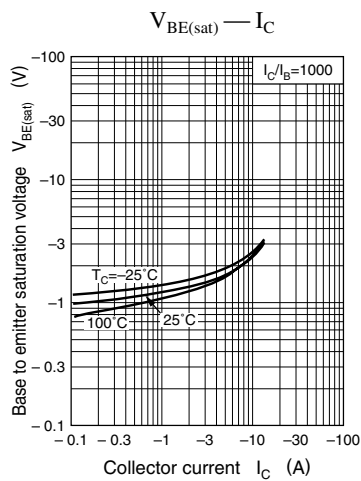
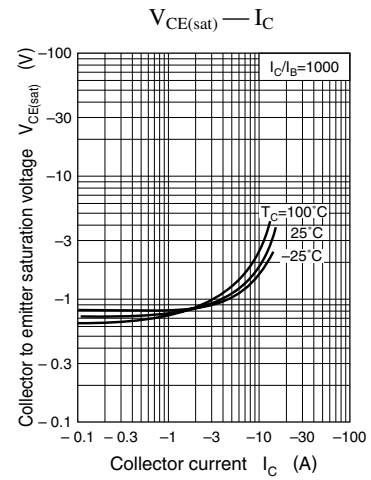
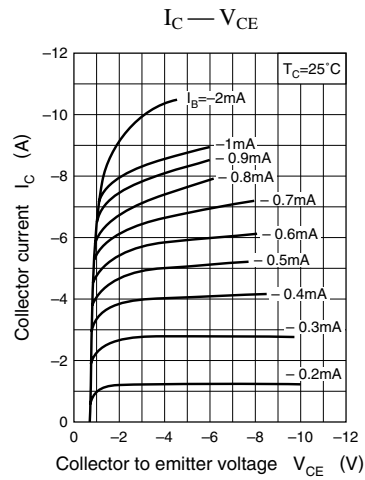
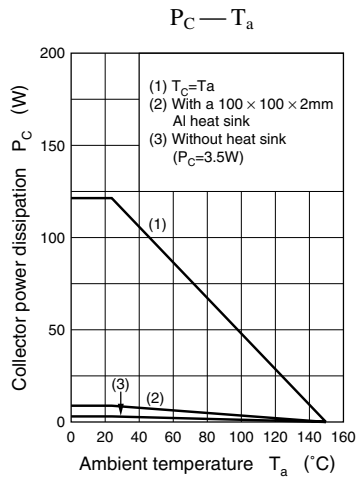


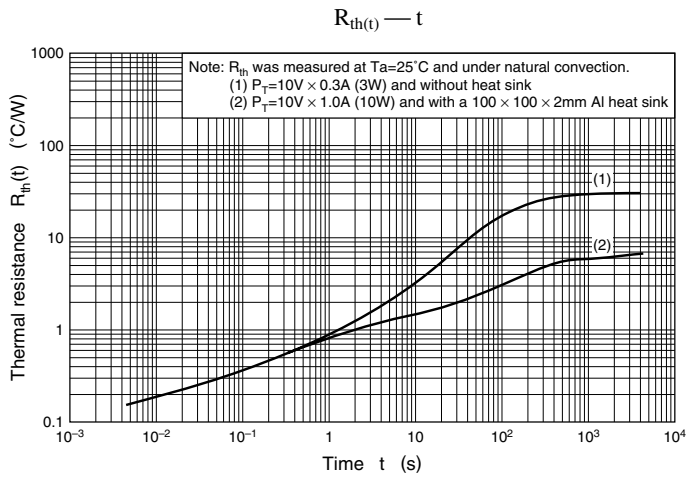
### ■ Electrical Characteristics $T_C = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector cutoff current	$I_{CBO}$	$V_{CB} = -160$ V, $I_E = 0$			-100	$\mu\text{A}$
	$I_{CEO}$	$V_{CE} = -140$ V, $I_B = 0$			-100	$\mu\text{A}$
Emitter cutoff current	$I_{EBO}$	$V_{EB} = -5$ V, $I_C = 0$			-100	$\mu\text{A}$
Collector to emitter voltage	$V_{CEO}$	$I_C = -30$ mA, $I_B = 0$	-140			V
Forward current transfer ratio	$h_{FE1}$	$V_{CE} = -5$ V, $I_C = -1$ A	2 000			
	$h_{FE2}^*$	$V_{CE} = -5$ V, $I_C = -7$ A	5 000		30 000	
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = -7$ A, $I_B = -7$ mA			-2.5	V
Base to emitter saturation voltage	$V_{BE(sat)}$	$I_C = -7$ A, $I_B = -7$ mA			-3.0	V
Transition frequency	$f_T$	$V_{CE} = -10$ V, $I_C = -0.5$ A, $f = 1$ MHz		20		MHz
Turn-on time	$t_{on}$	$I_C = -7$ A, $I_{B1} = -7$ mA, $I_{B2} = 7$ mA,		1.0		$\mu\text{s}$
Storage time	$t_{stg}$	$V_{CC} = -50$ V		1.5		$\mu\text{s}$
Fall time	$t_f$			1.2		$\mu\text{s}$

Note) \*: Rank classification

Rank	Q	S	P
$h_{FE2}$	5 000 to 15 000	7 000 to 21 000	8 000 to 30 000





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